ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Compo © Copyright 2005. IP international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mf	g Info	ormation			
Supplier Inform	nation															
Company name* Company unio				ique ID U			Unique ID Authority					Response Date*				
nsemi							I					2025-05-10				
Contact Name		Title - Contact			I	Phone - Contact*					Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com						
uthorized Repres	entative*	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Reques	ter Item Number	Mfr Iten	Number			Effective Da	ate Ve	Version M		Manufacturing Site		Weight* UOM		UOM	Unit Type	
				XDFN4 AD 3.3V LDO 250 mA, Ultra-Low Noise and High PSRR		2025-05-10 THB		ГНВ	· IB		1.3 mg		mg	Each		
Ianufacturing	Process Informat	ion														
Termina	nal Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MSL Rating		Peak Process Body Tempera		ody Temperatu	ture Max Time at Peak		Temperatu	Temperature Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		dAu) (no	CU Alloy		1	260			С		30 seco		ls 3	3		
Comments									· ·		·					·
vel 1 - maximum	time at peak temperatui	re during so	ldering is 10-3	0 seconds					<u> </u>							<u> </u>
or more informat	ion regarding material c	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.106267	mg	Supplier	Silicon (Si)	7440-21-3		0.1063	mg
Die Attach Tape	0.012345	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0019	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2-methyl-2-propenoate	25035-69-2		0.0019	mg
			Supplier	Proprietary	Proprietary Data		0.0012	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0056	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0019	mg
Lead Frame	0.778612	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0012	mg
			Supplier	Silicon (Si)	7440-21-3		0.0051	mg
			В	Nickel (Ni)	7440-02-0		0.0234	mg
			Supplier	Copper (Cu)	7440-50-8		0.749	mg
Mold Compound-Black	0.355444	mg		Epoxy resin	proprietary data		0.0167	mg
			Supplier	Phenol Resin	Proprietary Data		0.0167	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0004	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.3217	mg
Plating	0.024188	mg	Supplier	Palladium (Pd)	7440-05-3		0	mg
			В	Nickel (Ni)	7440-02-0		0.0242	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
Wire Bond - Au	0.023144	mg	Supplier	Gold (Au)	7440-57-5		0.0231	mg